

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J MOS[®] S2 series

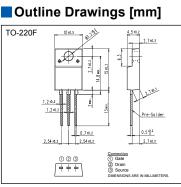
N-Channel enhancement mode power MOSFET

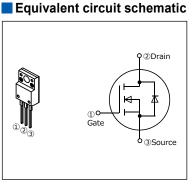
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at T_{vi}=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Durain Source Veltone	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Dusin Connent	l _o	23.9	А	T _{vj} =25°C Note*1,2
Continuous Drain Current		15.1	А	T _{vj} =100°C Note*1,2
Pulsed Drain Current	I _{DP}	71.6	А	Note *2
Gate-Source Voltage	V _{GS}	±30	V	
Non-Repetitive Maximum Avalanche Current	las	2.7	А	Note *3
Non-Repetitive Maximum Avalanche Energy	Eas	618	mJ	Note *4
Maximum Drain-Source dV/dt	dV₀s/dt	50	V/ns	V _{DS} ≤ 600V
Continuous	Isp	23.9	А	T _{vj} =25°C Note*1,2
Diode Forward Current		15.1	А	T _{vj} =100°C Note*1,2
Pulsed Diode Forward Current	ISDP	71.6	А	Note *2
Peak Diode Recovery dV/dt	dV/dt	15	V/ns	Note *5
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *6
	_	2.16		<i>T</i> _a =25°C
Maximum Power Dissipation	PD	45	W	<i>T</i> c=25°C
On anothing and Stangers Tampanatum and the	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	
Isolation Voltage (TO-220F)	Viso	2	kVrms	t=60sec,f=60Hz

Note *1 : Maximum duty cycle D=0.65 Note *2 : Limited by maximum channel temperature. Note *3 : 7ch≤150°C, See Fig.1 and Fig.2 Note *4 : Starting 7ch=25°C, /ks=1.7A, L=392mH, Vob=60V, Rc=50Ω, See Fig.1 and Fig.2 Eas limited by maximum channel temperature and avalanche current.

Note *5 : IsoS17.9A, -di/dtS100A/µs, Vos peak≤600V, 7ch≤150°C. Note *6 : IsoS17.9A, dV/dt≤15V/ns, Vos peak≤600V, 7ch≤150°C.

Electrical Characteristics at T_{vj}=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I₀=250µA		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I₀=0.95mA		3.5	4.0	4.5	V
Zero Gate Voltage Drain Current	Ioss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	<i>T</i> _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V _{DS} =0V V _{GS} =±30V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V I _D =9.0A		-	0.146	0.160	Ω
Gate resistance	RG	f=1MHz, open drain		-	9.8	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transconductance	g _{fs}	V _{DS} =25V I _D =9.0A	5.7	11.5	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	990	-	
Output Capacitance	Coss	V _{GS} =0V	-	35	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	5.3	-	
Effective output capacitance, energy related (Note *7)	C _{o(er)}	V _{DS} =0400V V _{GS} =0V	-	83	-	pF
Effective output capacitance, time related (Note *8)	Co(tr)	V _{DS} =0400V V _{GS} =0V I _D =constant	-	308	-	
	V_{DD} =400V, V_{GS} =10V	-	19	-		
Turn-On Time	tr	$V_{DD} = 4000, V_{GS} = 10V$ $I_0 = 9.0A,$ $R_G = 15\Omega$ See Fig.3 and Fig.4	-	63	-	- ns
td(off)	t _{d(off)}		-	87	-	
Turn-Off Time	<i>t</i> r		-	23	-	
Total Gate Charge	QG		-	43	-	
Gate-Source Charge	Q _{GS}	V_{DD} =400V, V_{GS} =10V	-	17	-]
Gate-Drain Charge	QGD	_ /₀=17.9A _ See Fig.5	-	16	-	nC
Drain-Source crossover Charge	Qsw		-	11	-]

Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V. Note *8 : $C_{0(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

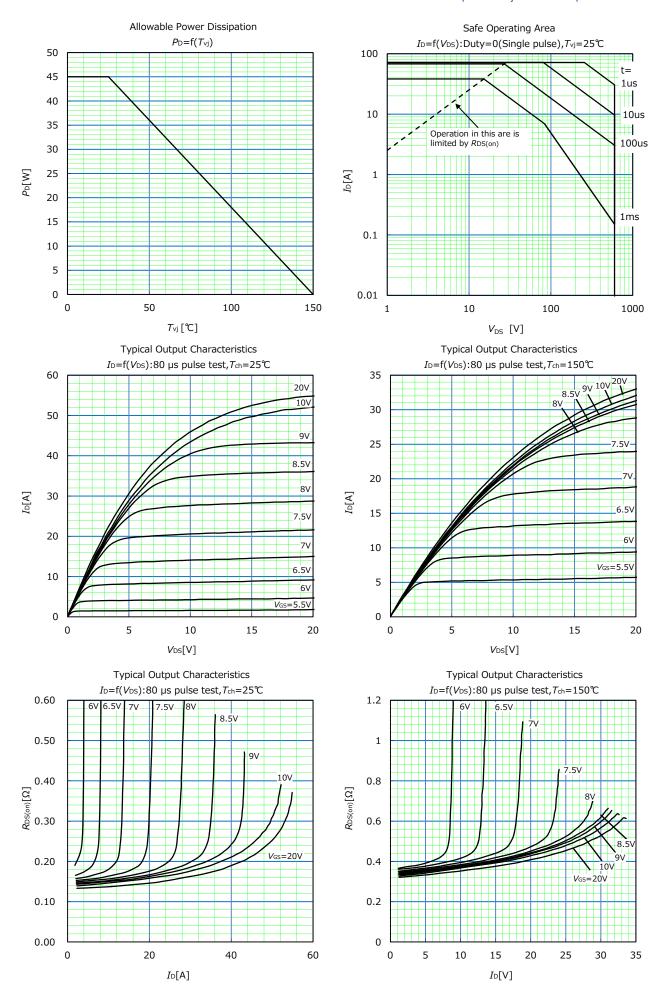
Reverse Diode

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Diode Forward On-Voltage	V _{SD}	I _{SD} =17.9A, V _{GS} =0V T _{ch} =25°C	-	0.90	1.35	V
Reverse Recovery Time	trr	- V₀₀=400V, /₅₀=17.9A -di/dt=100A/μs T₅h=25°C See Fig.6 and Fig.7	-	285	-	ns
Reverse Recovery Charge	Qrr		-	3.7	-	μC
Peak Reverse Recovery Current	Irp		-	25	-	А

Thermal Resistance

Parameter	Symbol	Min.	Тур.	Max.	Unit
Channel to Case	Rth(ch-c)	-	-	2.778	°C/W
Channel to Ambient	Rth(ch-a)	-	-	58	°C/W

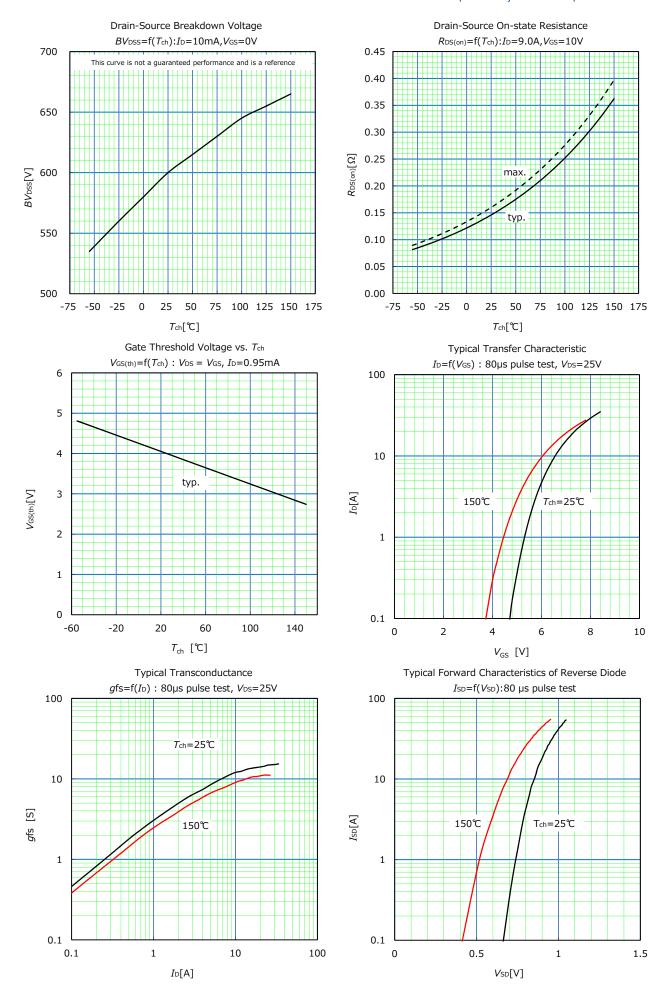
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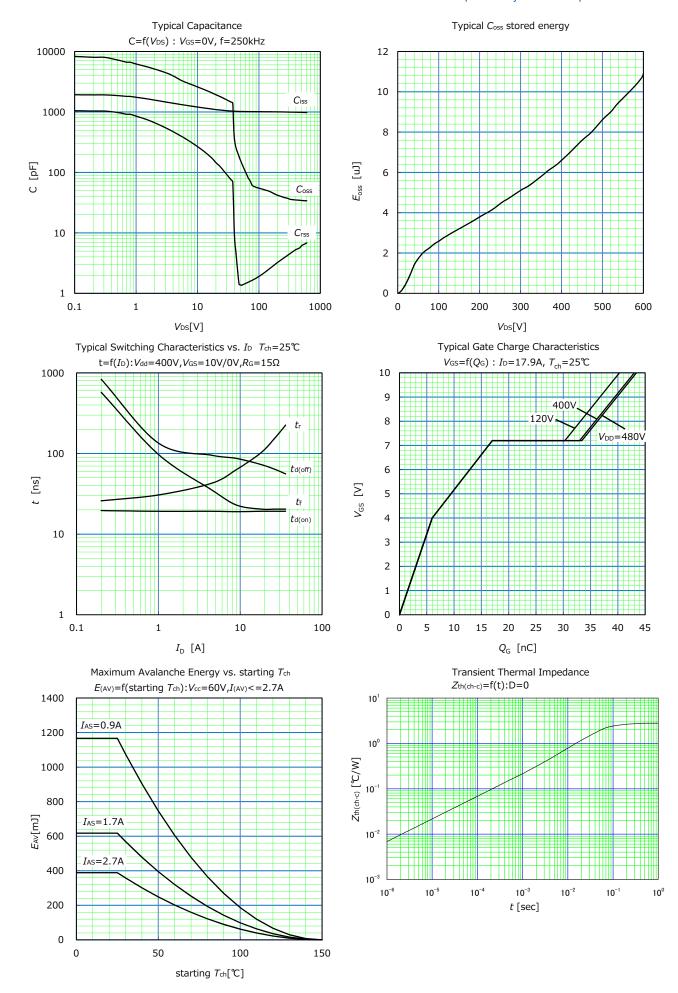
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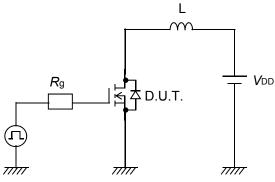


Fig.1 Avalanche Test circuit

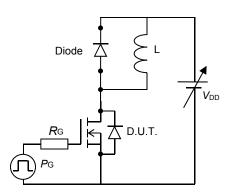


Fig.3 Switching Test circuit



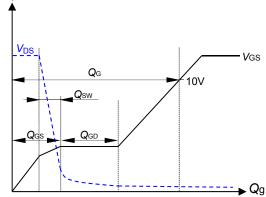
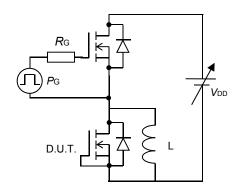
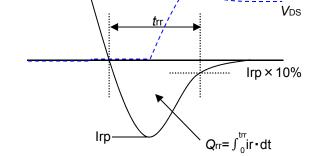


Fig.5 Operating waveform of Gate charge Test





. VDS peak

Fig.6 Reverse recovery Test circuit

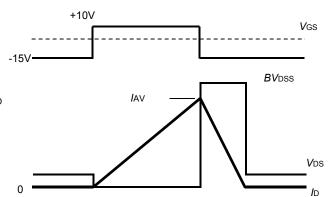


Fig.2 Operating waveforms of Avalanche Test

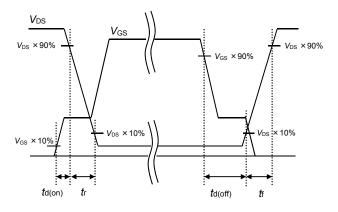


Fig.4 Operating waveform of Switching Test

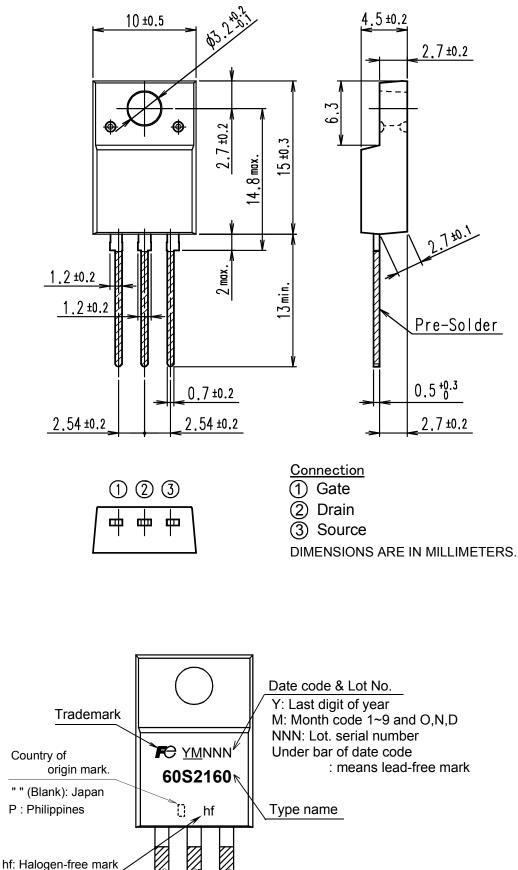
Fig.7 Operating waveform of Reverse recovery Test

Isd

Marking

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Outview: TO-220F(SLS) Package



* The font (font type,size) and the trademark-size might be actually different.

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